IPC  ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and N	Afg Informat	ion		
upplier Informa	tion														
Company name*			Company unique ID			J	Unique ID Authority				Respon	Response Date*			
n Semiconductor											2021-0	2021-02-03			
Contact Name			Title - Contact			I	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester l	Requester Item Number M		Mfr Item Number Mfr Item Name			Effe		Version	n .	Manufacturing Site		Weight*	UOM	Unit Type	
		BSS84LT	71	PFET SOT23 50V 1	130MA 10.0		2021-02-03					8.13	mg	Each	
	roccess Information		· 10		CTTD 020 MGI	D. d	D 1 D	D 1		W 75 - 2	1 77		CD C	,	
			•		STD-020 MSL	. Rating	Peak Process Body Tempera		Т,				per of Reflow Cyc	cles	
PbSn		C	U Alloy	1			235		IC	30	seco	nds 3			
omments			1. 1. 1. 10.1	10											
	ne at peak temperature														
or more information	regarding material cor	nposition p	olease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others, in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in formation the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 5 - Item(s	s) is obsolete, no information is available		Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required	fields on all pages of this form. Select the "Ac	cented" on the Supplier Acceptance dron-down	n This will display the signature area Digital	ly sign the declaration (if required by the							
Instructions: Complete all of the required Requester) and click on Submit Form to ha	fields on all pages of this form. Select the "Acave the form returned to the Requester.	ccepted" on the Supplier Acceptance drop-down	n. This will display the signature area. Digital	ly sign the declaration (if required by the							

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg
Lead Frame	2.92		Supplier	Silver (Ag)	7440-22-4		0.5198	mg
			В	Nickel (Ni)	7440-02-0		0.9023	mg
			Supplier	Iron (Fe)	7439-89-6		1.2468	mg
			Supplier	Copper (Cu)	7440-50-8		0.2511	mg
Mold Compound-Black	4.9		Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.49	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7105	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.185	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.49	mg
Plating	0.14	mg	A	Lead (Pb)	7439-92-1		0.028	mg
			Supplier	Tin (Sn)	7440-31-5		0.112	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg